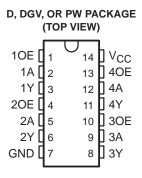
## SN74ALVC126 QUADRUPLE BUS BUFFER GATE WITH 3-STATE OUTPUTS

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- EPIC™ (Enhanced-Performance Implanted CMOS) Submicron Process
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Package Options Include Plastic Small-Outline (D), Thin Very Small-Outline (DGV), and Thin Shrink Small-Outline (PW) Packages



### description

This quadruple bus buffer gate is designed for 1.65-V to 3.6-V V<sub>CC</sub> operation.

The SN74ALVC126 features independent line drivers with 3-state outputs. Each output is disabled when the associated output-enable (OE) input is low.

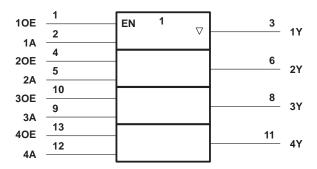
To ensure the high-impedance state during power up or power down, OE should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

The SN74ALVC126 is characterized for operation from -40°C to 85°C.

## FUNCTION TABLE (each buffer)

INP	JTS	OUTPUT				
OE	Α	Y				
Н	Н	Н				
Н	L	L				
L	Χ	Z				

#### logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



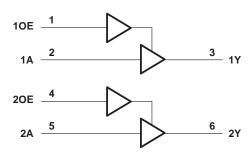
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

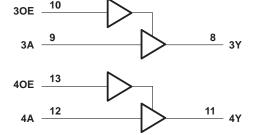
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### logic diagram (positive logic)





### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>		–0.5 V to 4.6 V
Input voltage range, V <sub>I</sub> (see Note 1)		–0.5 V to 4.6 V
Output voltage range, V <sub>O</sub> (see Notes 1 and 2)		–0.5 V to V <sub>CC</sub> + 0.5 V
Input clamp current, $I_{IK}$ ( $V_I < 0$ )		
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0)		–50 mA
Continuous output current, IO		±50 mA
Continuous current through V <sub>CC</sub> or GND		±100 mA
Package thermal impedance, θ <sub>JA</sub> (see Note 3):	: D package	127°C/W
•	DGV package	182°C/W
	PW package	170°C/W
Storage temperature range, T <sub>stq</sub>		–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

- 2. This value is limited to 4.6 V maximum.
- 3. The package thermal impedance is calculated in accordance with JESD 51.



## SN74ALVC126 QUADRUPLE BUS BUFFER GATE WITH 3-STATE OUTPUTS

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## recommended operating conditions (see Note 4)

			MIN	MAX	UNIT	
Vcc	Supply voltage		1.65	3.6	V	
		V <sub>CC</sub> = 1.65 V to 1.95 V	0.65 × V <sub>CC</sub>			
٧ıH	High-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7		V	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2			
	Low-level input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V		0.35 × V <sub>CC</sub>		
٧ <sub>IL</sub>		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.7	V	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$		0.8		
٧ <sub>I</sub>	Input voltage		0	Vcc	V	
٧o	Output voltage		0	Vcc	V	
	High-level output current	V <sub>CC</sub> = 1.65 V		-4	mA	
la		V <sub>CC</sub> = 2.3 V		-12		
ЮН		V <sub>CC</sub> = 2.7 V		-12		
		V <sub>CC</sub> = 3 V		-24		
		V <sub>CC</sub> = 1.65 V		4		
1	Low-level output current	V <sub>CC</sub> = 2.3 V		12	mA	
IOL		V <sub>CC</sub> = 2.7 V		12		
		V <sub>CC</sub> = 3 V		24		
Δt/Δν	Input transition rise or fall rate			5	ns/V	
T <sub>A</sub>	Operating free-air temperature		-40	85	°C	

NOTE 4: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



## SN74ALVC126 QUADRUPLE BUS BUFFER GATE WITH 3-STATE OUTPUTS

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## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

P/	ARAMETER	TEST CONDITIONS	vcc	MIN TYPT	MAX	UNIT		
		I <sub>OH</sub> = -100 μA	1.65 V to 3.6 V	V <sub>CC</sub> -0.2				
		$I_{OH} = -4 \text{ mA}$	1.65 V	1.2				
		$I_{OH} = -6 \text{ mA}$	2.3 V	2				
Vон			2.3 V	1.7		V		
		$I_{OH} = -12 \text{ mA}$	2.7 V	2.2				
			3 V	2.4				
		$I_{OH} = -24 \text{ mA}$	3 V	2				
		I <sub>OL</sub> = 100 μA	1.65 V to 3.6 V		0.2	V		
		I <sub>OL</sub> = 4 mA	1.65 V		0.45			
\/ ~ ·		I <sub>OL</sub> = 6 mA	2.3 V		0.4			
VOL		la. 42 mA	2.3 V		0.7			
		I <sub>OL</sub> = 12 mA	2.7 V		0.4			
		I <sub>OL</sub> = 24 mA	3 V		0.55			
IĮ		V <sub>I</sub> = V <sub>CC</sub> or GND	3.6 V		±5	μА		
loz		$V_O = V_{CC}$ or GND	3.6 V		±10	μА		
Icc		$V_I = V_{CC}$ or GND, $I_O = 0$	3.6 V		10	μА		
Δlcc		One input at V <sub>CC</sub> – 0.6 V, Other inputs at V <sub>CC</sub> or GND	3 V to 3.6 V		750	μА		
C <sub>i</sub>	Control inputs	Vi – Viag or CND	3.3 V	3.5		n.E		
	Data inputs	V <sub>I</sub> = V <sub>CC</sub> or GND	3.3 v	3.5		pF		
Со	Outputs	$V_O = V_{CC}$ or GND	3.3 V	5.5		pF		

<sup>†</sup> All typical values are at  $V_{CC} = 3.3 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

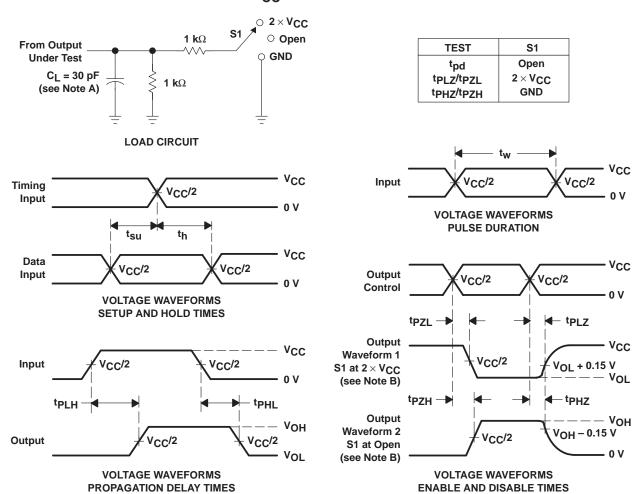
# switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = 1.8 V V <sub>CC</sub> = 2.5 V ± 0.15 V ± 0.2 V		V <sub>CC</sub> = 2.7 V		V <sub>CC</sub> = 3.3 V ± 0.3 V		UNIT		
	(IIVFO1)	(001701)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>pd</sub>	А	Υ	1.3	5.6	1	3.4		3.4	1.1	3.1	ns
t <sub>en</sub>	OE	Υ	1	5.9	1	3.8		3.8	1	3.3	ns
<sup>t</sup> dis	OE	Y	1.8	5.6	1	3.3		4.4	1	3.7	ns

## operating characteristics, T<sub>A</sub> = 25°C

PARAMETER		TEST CONDITIONS	V <sub>CC</sub> = 1.8V	V <sub>CC</sub> = 2.5 V TYP	V <sub>CC</sub> = 3.3 V	UNIT	
C . Power dissipation		Outputs enabled	C <sub>L</sub> = 0,	15	17	19	pF
Сра	C <sub>pd</sub> capacitance per gate	Outputs disabled	f = 10 MHz	2	2	3	рг

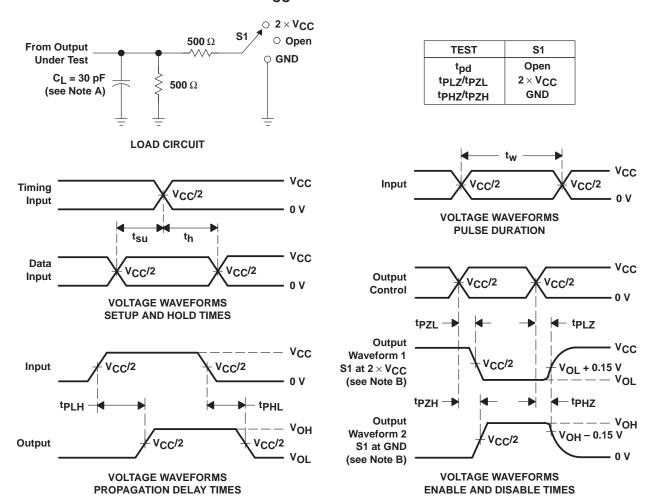
#### PARAMETER MEASUREMENT INFORMATION $V_{CC} = 1.8 V \pm 0.15 V$



- NOTES: A. C<sub>L</sub> includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ ,  $t_r \leq$  2 ns,  $t_f \leq$  2 ns.
  - D. The outputs are measured one at a time with one transition per measurement.
  - E. tpLz and tpHz are the same as tdis.
  - F. tpzL and tpzH are the same as ten.
  - G. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms

## PARAMETER MEASUREMENT INFORMATION $V_{CC}$ = 2.5 V $\pm$ 0.2 V



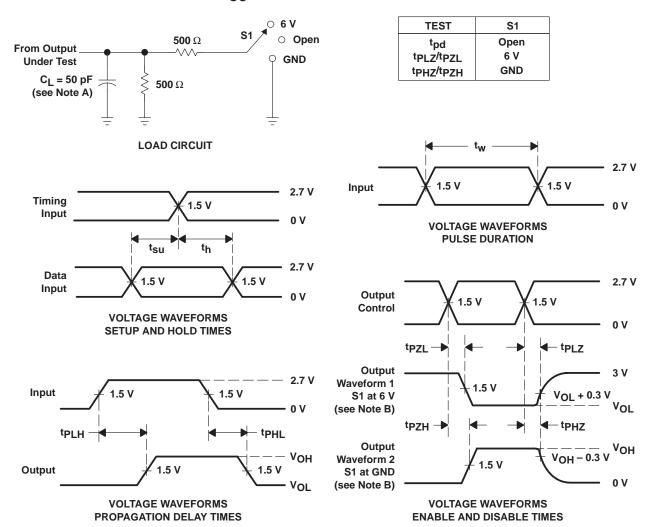
NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_Q$  = 50  $\Omega$ ,  $t_f \leq$  2 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as t<sub>Dd</sub>.

Figure 2. Load Circuit and Voltage Waveforms



#### PARAMETER MEASUREMENT INFORMATION $V_{CC} = 2.7 \text{ V AND } 3.3 \text{ V} \pm 0.3 \text{ V}$



- NOTES: A. C<sub>L</sub> includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ ,  $t_f \leq$  2.5 ns.  $t_f \leq$  2.5 ns.
  - D. The outputs are measured one at a time with one transition per measurement.
  - E. tpLZ and tpHZ are the same as tdis.
  - F. tpzL and tpzH are the same as ten.
  - G. tpLH and tpHL are the same as tpd.

Figure 3. Load Circuit and Voltage Waveforms

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